ELECTRONICS, INC.
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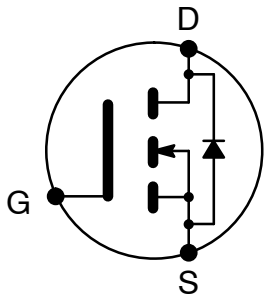
NTE2949
MOSFET
N–Channel, Enhancement Mode
High Speed Switch
TO–220 Full Pack Type Package



Features:
- Ultra Low Gate Charge
- Periodic Avalanche Rated
- Extreme dv/dt Rated
- High Peak Current Capability
- Improved Transconductance

Absolute Maximum Ratings:

Continuous Drain Current, I_D
- T_C = +25°C 20.7A
- T_C = +100°C 13.1A

Pulsed Drain Current (t_p limited by $T_J$max), I_{Dpuls} 62.1A
Single Pulse Avalanche Energy (I_D = 10A, V_{DD} = 50V), E_{AS} 690mJ
Repetitive Avalanche Energy (t_{AR} limited by $T_J$max, I_D = 10A, V_{DD} = 50V, Not 2), E_{AR} 1mJ
Repetitive Avalanche Current (t_{AR} limited by $T_J$max), I_{AR} 20A
Gate–Source Voltage, V_{GS}
- Static . . . . . ±20V
- AC (f > 1Hz) . . . . . ±30V

Total Power Dissipation (T_C = +25°C), P_{tot} 34.5W
Reverse Diode dv/dt (Note 3), dv/dt 15V/ns
Drain–Source Voltage Slope (V_{DS} = 480V, I_D = 20.7A, T_J = +125°C), dv/dt 50V/ns
Junction Temperature Range, T_J . . . . . –55° to +150°C
Storage Temperature Range, T_{stg} . . . . . –55° to +150°C
Lead Temperature (wavesoldering, .063” 1[.6mm] from case, 10sec), T_{sold} . . . . . +260°C
Thermal Resistance, Junction–to–Case, R_{thJC} 3.6K/W
Thermal Resistance, Junction–to–Ambient, R_{thJA} 80K/W

Note 1. Limited only by maximum temperature.
Note 2. Repetitive avalanche causes additional power losses that can be calculated as $P_{AV} = E_{AR} + f$.
Note 3. $I_{SD} \le I_D$, di/dt ≤ 400A/μs, V_{DClink} = 400V, $V_{peak} < V_{(BR)DSS}$, $T_J < T_{Jmax}$, identical low–side and high–side switch.

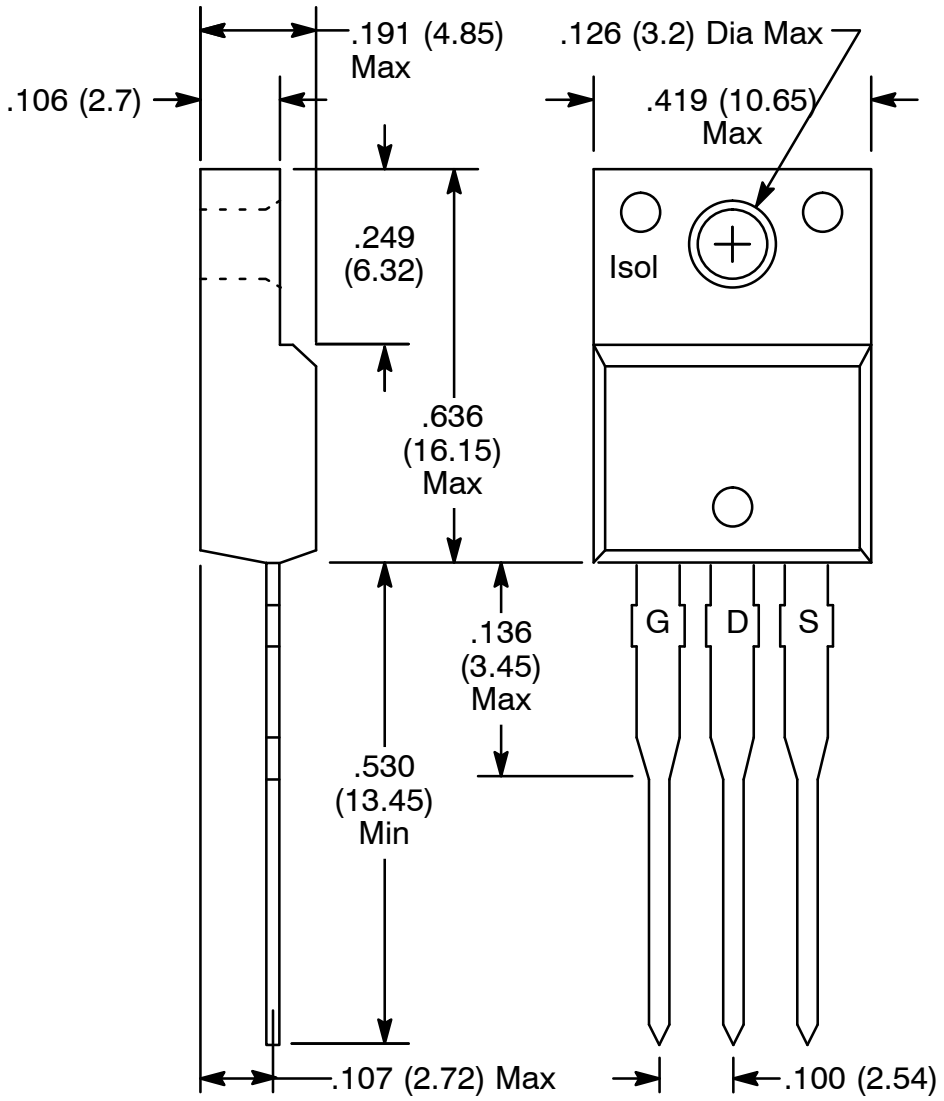
RoHS 2002/95/EC

Electrical Characteristics: (T_J = +25°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain–Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 0.25mA	600	–	–	V
Gate–Source Avalanche Breakdown Voltage	$V_{(BR)DS}$	V_{GS} = 0V, I_D = 20A	–	700		V
Gate Threshold Voltage	$V_{GS(th)}$	I_D = 1000μA, V_{GS} = V_{DS}	2.1	3.0	3.9	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 600V, V_{GS} = 0, T_J = +25°C	–	0.1	1.0	μA
		V_{DS} = 600V, V_{GS} = 0, T_J = +100°C	–	–	100	μA
Gate–Source Leakage Current	I_{GSS}	V_{GS} = 30V, V_{DS} = 0V	–	–	100	nA
Drain–Source ON–State Resistance	$R_{DS(on)}$	V_{GS} = 10V, I_D = 13.1A, T_J = +25°C	–	0.16	0.19	Ω
		V_{GS} = 10V, I_D = 13.1A, T_J = +150°C	–	0.43	–	W
Gate Input Resistance	R_G	f = 1MHz, Open Drain	–	0.54	–	W
Transconductance	g_{fs}	V_{DS} 2 * I_D * $R_{DS(on)}$max, I_D = 13.1A	–	17.5	–	S
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 25V, f = 1MHz	–	2400	–	pF
Output Capacitance	C_{oss}		–	780	–	pF
Reverse Transfer Capacitance	C_{rss}		–	50	–	pF
Effective Output Capacitance, Energy Related	$C_{o(er)}$	V_{GS} = 0V, V_{DS} = 0 to 480V, Note 4	–	83	–	pF
Effective Output Capacitance, Time Related	$C_{o(tr)}$	V_{GS} = 0V, V_{DS} = 0 to 480V, Note 5	–	100	–	pF
Turn–On Delay Time	$t_{d(on)}$	V_{DD} = 380V, V_{GS} = 0 to 13V, I_D = 20.7A	–	10	–	ns
Rise Time	t_r		–	5	–	ns
Turn–Off Delay Time	$t_{d(off)}$		–	67	100	ns
Fall Time	t_f		–	4.5	12	ns
Gate–Source Charge	Q_{gs}	V_{DD} = 480V, I_D = 20.7A	–	11	–	nC
Gate–Drain Charge	Q_{gd}		–	33	–	nC
Gate Charge Total	Q_g	V_{DD} = 480V, I_D = 20.7A, V_{GS} = 0 to 10V	–	87	114	nC
Gate Plateau Voltage	$V_{(plateau)}$	V_{DD} = 480V, I_D = 20.7A	–	5.5	–	V
Inverse Diode Continuous Forward Current	I_S	T_C = 25°C	–	–	20.7	A
Inverse Diode Direct Current Pulsed	I_{SM}	T_C = 25°C	–	–	62.1	A
Inverse Diode Forward Voltage	V_{SD}	V_{GS} = 0V, I_F = I_S	–	1.0	1.2	V
Reverse Recovery Time	t_{rr}	V_R = 480V, I_F = I_S, di_F/dt = 100A/μs	–	500	800	ns
Reverse Recovery Charge	Q_{rr}		–	11	–	μC
Peak Reverse Recovery Current	I_{rrm}		–	70	–	A
Peak Rate of Fall of Reverse Recovery Current	di_{rr}/dt	T_J = +25°C	–	1400	–	A/μs

Note 4. $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}.

Note 5. $C_{o(er)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}.


.191 (4.85)
Max
.106 (2.7)
.126 (3.2) Dia Max
.419 (10.65)
Max
.249
(6.32)
Isol
.636
(16.15)
Max
.136
(3.45)
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S
.530
(13.45)
Min
.107 (2.72) Max
.100 (2.54)